



General Information	
Series	KPS SMD Comm X7R
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Single Chip, Temperature Stable
Features	Temperature Stable
RoHS	Yes
Termination	Tin
AEC-Q200	No
Component Weight	410 mg
Chip Size	2220-1
Shelf Life	78 Weeks
MSL	1

Click here for the 3D model.

Dimensions	
L	6mm +/-0.5mm
W	5mm +/-0.5mm
т	3.5mm +/-0.30mm
В	1.6mm +/-0.3mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	1300

Specifications	
Capacitance	3.3 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	20%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	303 MOhms

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